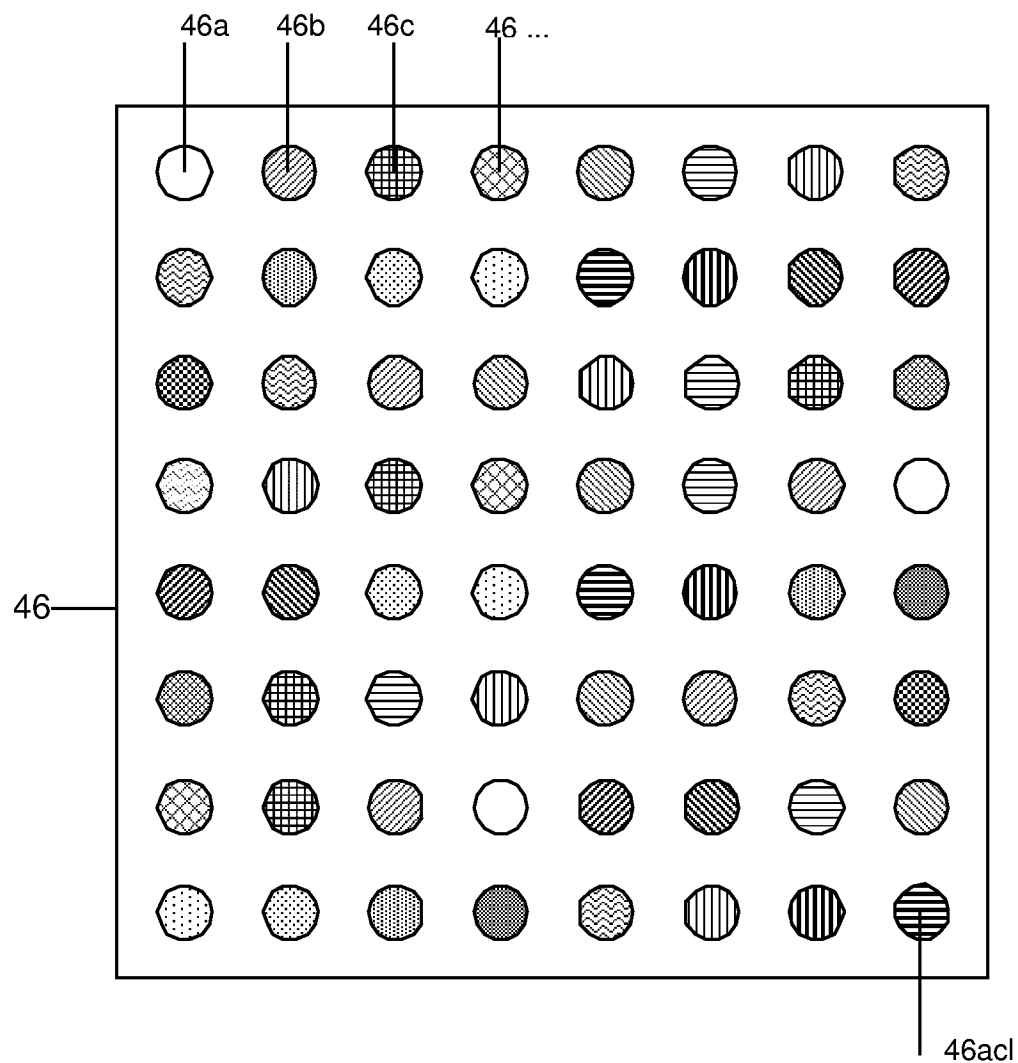


For: HIGH THROUGHPUT PHYSICAL VAPOR DEPOSITION SYSTEM  
FOR MATERIAL COMBINATORIAL STUDIES

Inventor: HE, Ting et al.

Contact: Edwin M. Baranowski

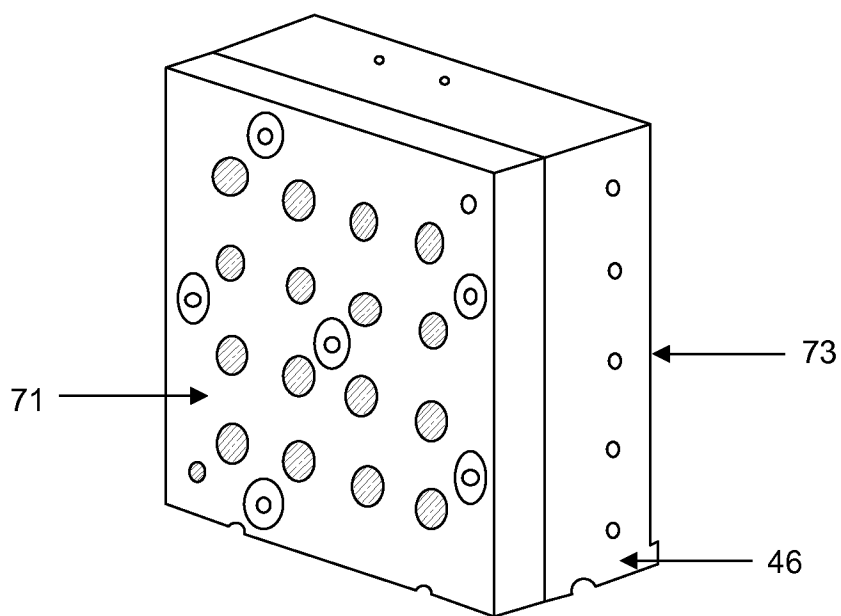
**FIGURE 4D**



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**Figure 7A**

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**Figure 7B**

